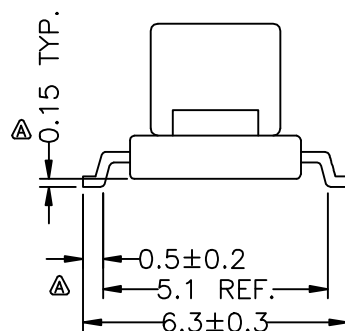
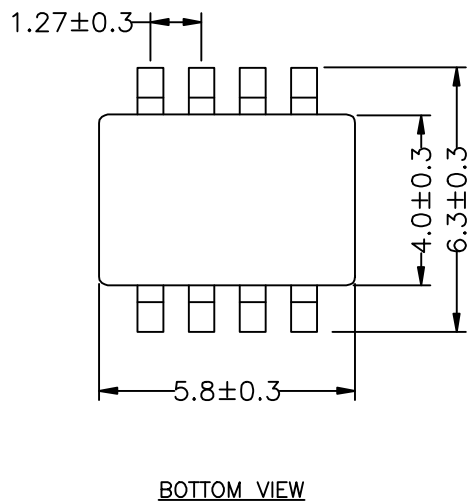
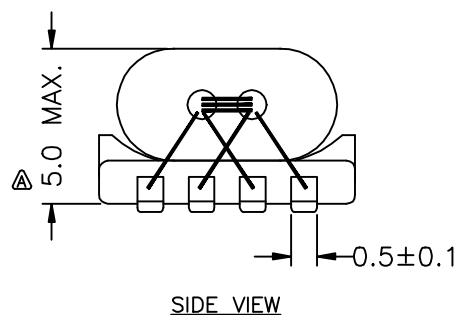
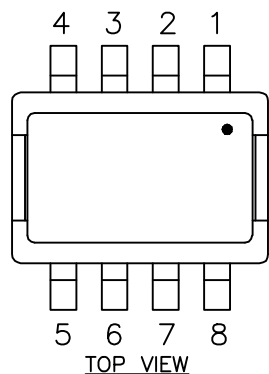
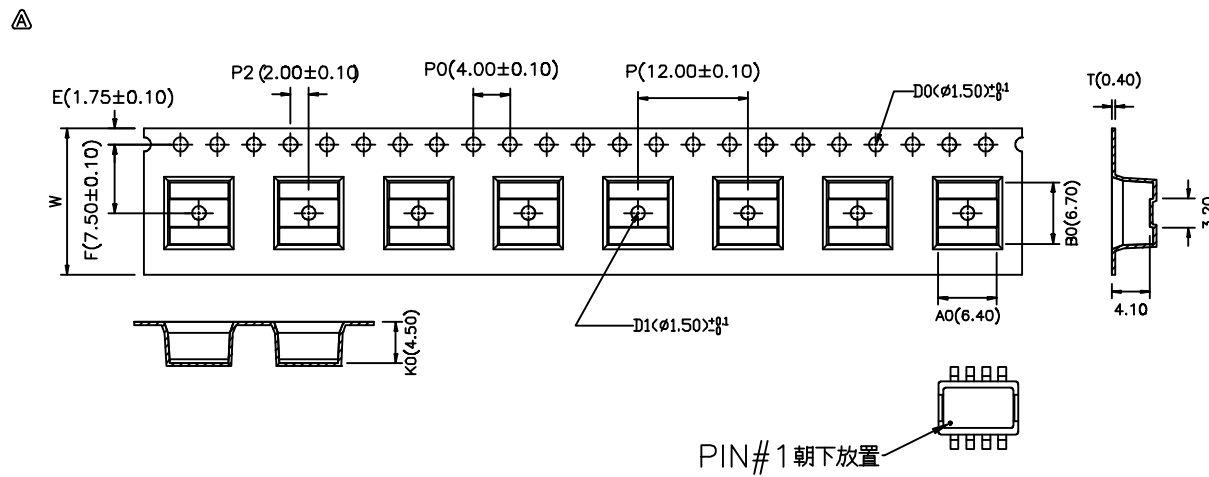


ELECTRICAL CHARACTERISTICS :

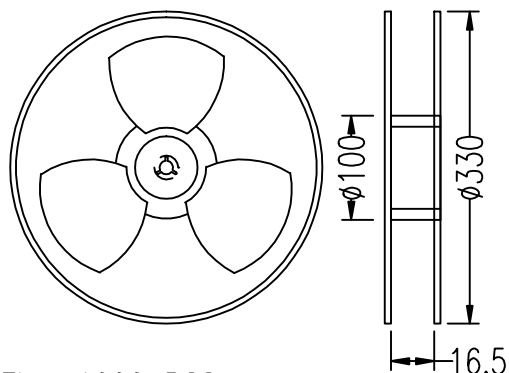
- DCR : PIN 1-2 = 110mΩ MAX. , PIN 3-4 = 110mΩ MAX.
PIN 5-6 = 150mΩ MAX. , PIN 7-8 = 200mΩ MAX.
- INDUCTANCE (@10KHz, 100mVrms) :
PIN 1-4 (PIN 2-3 SHORT) = 48uH MIN.
- LEAKAGE INDUCTANCE (@200KHz, 0.1Vrms) :
PIN 1-4 (PIN 2-3 SHORT, PIN 5,6,7,8 SHORT) = 150nH MAX.
- INTERWINDING CAPACITANCE (@100KHz, 0.1Vrms) :
PIN 1-8 (PIN 2-3, PIN 6-7 SHORT) = 8.5pF MAX.
- TURN RATIO (@100KHz, 0.1Vrms) :
PIN 1-4 (PIN 2-3 SHORT) : 6-5 = 1.5 ±2%
PIN 1-4 (PIN 2-3 SHORT) : 8-7 = 1 ±2%
- HI-POT (@600VAC, 5mA, 1SEC) :
PIN 1 (PIN 2-3 SHORT) - PIN 8 (PIN 6-7 SHORT)
- RoHS COMPLIANTE

								TITLE TRANSFORMER
A	CHANGE DIM.	05/21/2024	SHIRLEY	RURU	RURU			DWG. NO. PL-041R
	RELEASE	04/12/2013	SHIRLEY	RONAN	RONAN	UNITS: M/M		SHEET 1 of 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	DRAW
REVISIONS						04/12/2013		SHIRLEY

DIRECTION OF FEED



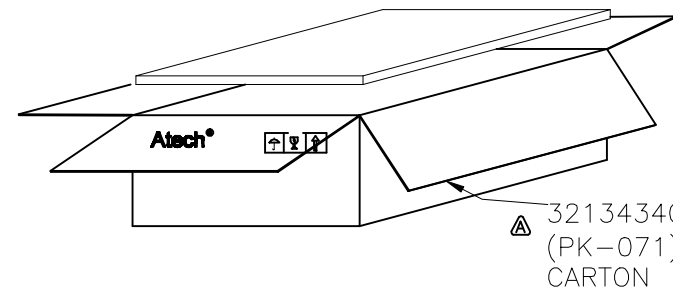
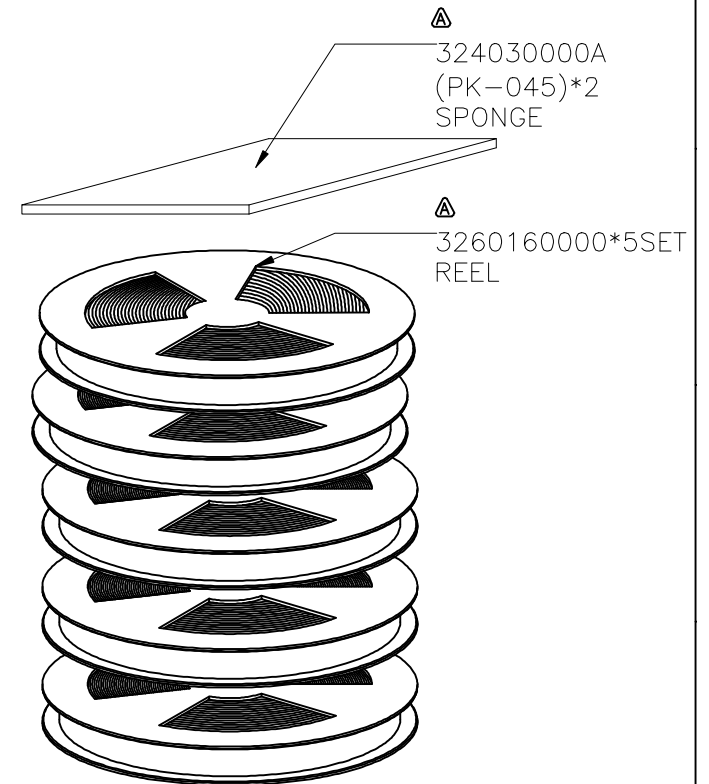
ITEM	W	A0	B0	K0	P	F	E	D0	D1	P0	P2	T
DIM.	16.0 $\begin{smallmatrix} +0.30 \\ -0.10 \end{smallmatrix}$	6.4 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	6.7 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	4.5 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	12.0 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	7.5 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	1.75 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	1.5 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	1.5 $\begin{smallmatrix} +0.10 \\ -0.00 \end{smallmatrix}$	4.0 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	2.0 $\begin{smallmatrix} +0.10 \\ -0.10 \end{smallmatrix}$	0.40 $\begin{smallmatrix} +0.05 \\ -0.05 \end{smallmatrix}$



△ 1 REEL : 1000 PCS
1 CARTON : 5 REEL (5000PCS)

每捲放乾燥包1pcs 用真空袋抽真空封口
2780000001 3255048424

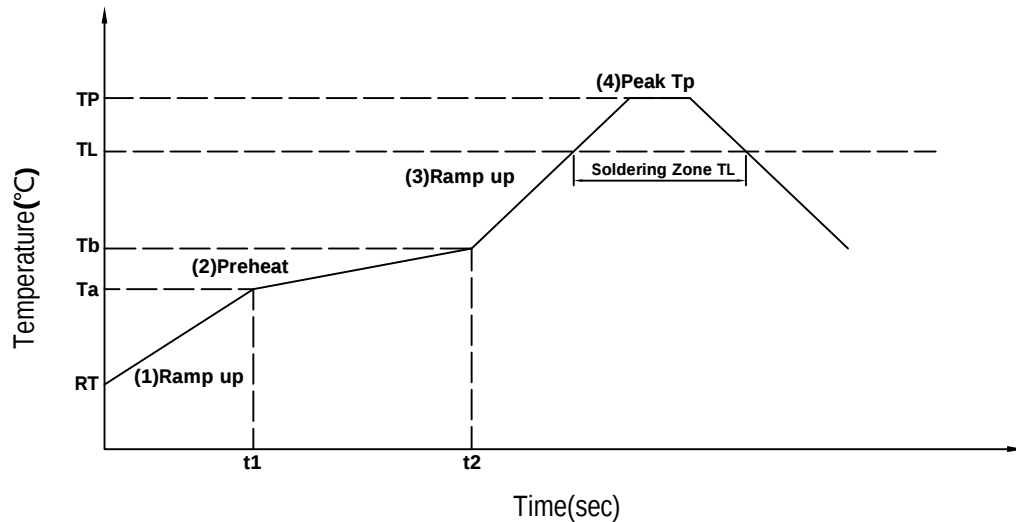
每13"卷軸可裝1000PCS零件,前後各空28PCS空格



						TITLE		PACKING	
						DWG. NO.		968S106700	
A	CHANGE PACKING	07/25/2023	SHIRLEY	TINA	TINA	UNITS:		SAFETY	
	RELEASE	10/12/2011	SHIRLEY	JOAN	JOAN	M/M		SHEET 1 of 1	
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE		P/N:	
REVISIONS						10/12/11		DRAW	
								Shirley	



Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85%
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C